

Test Your Dream !

AF8652D6

Burn-in & Test System

AF8652D6, is specifically designed to test both MaskROM and SDRAM devices in mass production scale, it can execute data programming verifying the devices without spending High-costs.

- Number of zone : 1 zone(Temp/Control)
- Number of slot : 48 slots, 4 racks, 12slots/rack
- Number of oven : 1 oven
- Temperature : -10℃ ~ 150℃
- Temp. Resolution : 0.1℃
- Temp. accuracy : $\pm 3^{\circ}\text{C}$ (-10℃ ~ +125℃)
 $\pm 5^{\circ}\text{C}$ (+125℃ ~ +150℃)
- Burn-in Board Size : 450mm× 570mm×1.6mm
- Burn-in Board Density : Depend on power consumption
- Burn-in Board ID : 24 bits
- ALPG address : 44bits (X : 22bits, Y : 22bits)
- Power voltage range : PS1/PS2/PS3/PS4 : +0.5V ~ +10V / 15A
PS1/PS2 : +0.5V ~ +10V / 30A



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